DATA SHEET



MOS FIELD EFFECT TRANSISTOR 2SK3306

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK3306 is N-Channel DMOS FET device that features a low gate charge and excellent switching characteristics, and designed for high voltage applications such as switching power supply, AC adapter.

ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3306	Isolated TO-220 (MP-45F)



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- Low gate charge :
- $Q_G = 13 \text{ nC TYP.}$ (VDD = 400 V, VGS = 10 V, ID = 5.0 A)
- Gate voltage rating : $\pm 30 \text{ V}$
- Low on-state resistance : $R_{DS(on)} = 1.5 \Omega MAX. (V_{GS} = 10 V, I_{D} = 2.5 A)$
- Avalanche capability ratings
- Isolated TO-220(MP-45F) package

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	500	V
Gate to Source Voltage ($V_{DS} = 0 V$)	VGSS(AC)	±30	V
Drain Current (DC)	D(DC)	±5	А
Drain Current (pulse) Note1	D(pulse)	±20	А
Total Power Dissipation (Tc = 25°C)	Ρτ	35	W
Total Power Dissipation (TA = 25°C)	Р⊤	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	–55 to +150	°C
Single Avalanche Current Note2	las	5.0	А
Single Avalanche Energy ^{Note2}	Eas	125	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1 %

2. Starting Tch = 25 °C, VDD = 150 V, RG = 25 $\Omega,$ VGS = 20 V \rightarrow 0 V

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(Isolated TO-220)



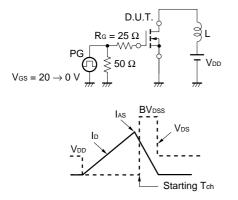
CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain Leakage Current	loss			100	μA	$V_{DS} = 500 V, V_{GS} = 0 V$
Gate to Source Leakage Current	lgss			±100	nA	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$
Gate to Source Cut-off Voltage	V _{GS(off)}	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	y _{fs}	1.0	3.0		S	Vds = 10 V, Id = 2.5 A
Drain to Source On-state Resistance	RDS(on)		1.35	1.5	Ω	Vgs = 10 V, Id = 2.5 A
Input Capacitance	Ciss		700		pF	$V_{DS} = 10 V$, $V_{GS} = 0 V$, $f = 1 MHz$
Output Capacitance	Coss		115		pF	
Reverse Transfer Capacitance	Crss		6		pF	
Turn-on Delay Time	td(on)		16		ns	$V_{DD} = 150 \text{ V}, \text{ ID} = 2.5 \text{ A}, \text{ Vgs}_{(on)} = 10 \text{ V}$
Rise Time	tr		3		ns	$R_G = 10 \Omega$, $R_L = 60 \Omega$
Turn-off Delay Time	$t_{d(off)}$		33		ns	
Fall Time	tr		5.5		ns	
Total Gate Charge	QG		13		nC	$V_{DD} = 400 V, V_{GS(on)} = 10 V, I_D = 5.0 A$
Gate to Source Charge	Q _{GS}		4		nC	
Gate to Drain Charge	Qgd		4.5		nC	
Body Diode Forward Voltage	VF(S-D)		1.0		V	IF = 5.0 A, VGS = 0 V
Reverse Recovery Time	trr		0.7		μs	$I_F = 5.0 \text{ A}, \text{ V}_{GS} = 0 \text{ V}, \text{ di/dt} = 50 \text{ A}/\mu \text{s}$
Reverse Recovery Charge	Qrr		3.3		μC	

ELECTRICAL CHARACTERISTICS (TA = 25 °C)

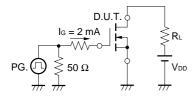
NEC

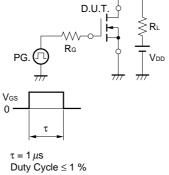
TEST CIRCUIT 1 AVALANCHE CAPABILITY

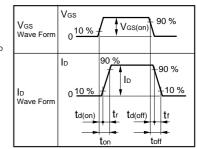
TEST CIRCUIT 2 SWITCHING TIME



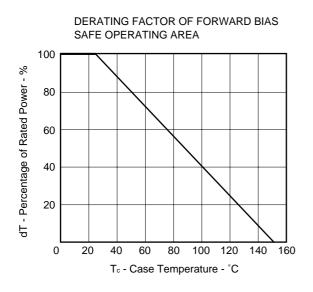
TEST CIRCUIT 3 GATE CHARGE



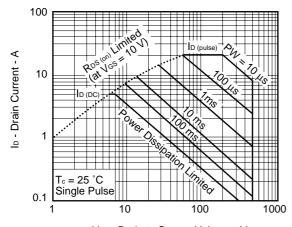






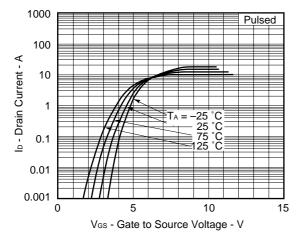


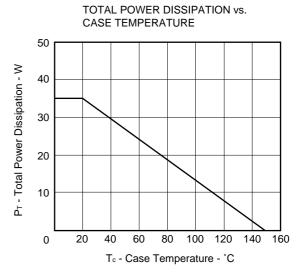
FORWARD BIAS SAFE OPERATING AREA



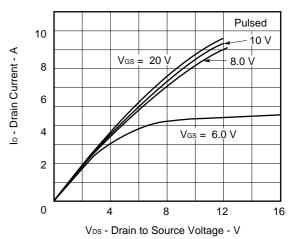
 $V_{\mbox{\scriptsize DS}}$ - Drain to Source Voltage - V

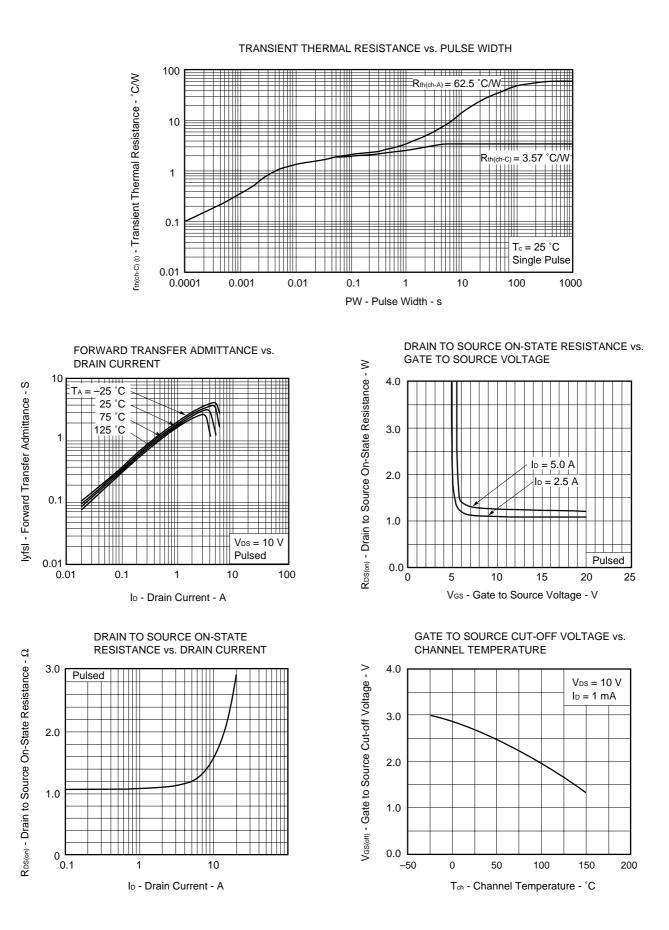
DRAIN CURRENT vs. GATE TO SOURCE VOLTAGE

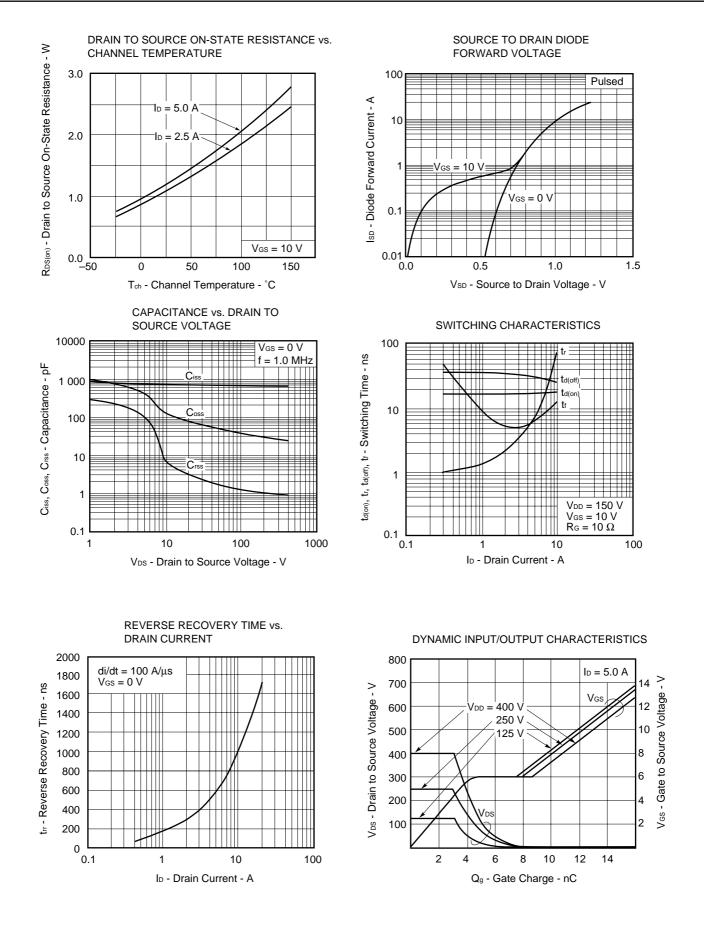




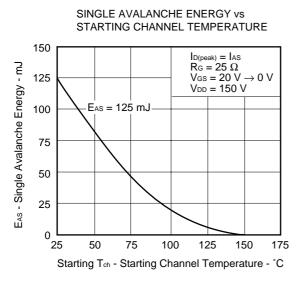
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



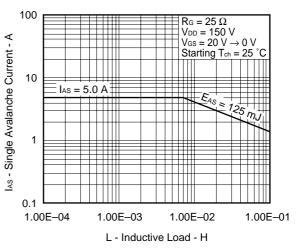




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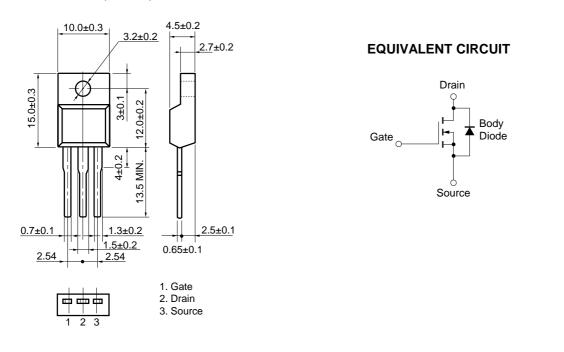






PACKAGE DRAWING (Unit: mm)

Isolated TO-220(MP-45F)



★ Remark Strong electric field, when exposed to this device, cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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